Y5V Dielectric, 6.3 – 50 VDC (Commercial Grade)

Overview

KEMET's Y5V dielectric features an 85°C maximum operating temperature and is considered "general-purpose." The Electronics Industries Alliance (EIA) characterizes Y5V dielectric as a Class III material. Components of this classification are fixed, ceramic dielectric capacitors, suited for bypass and decoupling or other applications in which dielectric losses, high insulation resistance and

capacitance stability are not of major importance. Y5V exhibits a predictable change in capacitance with respect to time and voltage, and displays wide variations in capacitance with reference to ambient temperature. Capacitance change is limited to +22%, -82% from -30°C to +85°C.

Benefits

- -30°C to +85°C operating temperature range
- · Lead (Pb)-free, RoHS and REACH compliant
- EIA 0402, 0603, 0805, 1206, and 1210 case sizes
- DC voltage ratings of 6.3 V, 10 V, 16 V, 25 V, and 50 V
- Capacitance offerings ranging from 0.022 μF to 22 μF
- Available capacitance tolerance of ±20% and +80%/-20%
- Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish that allows for excellent solderability

Applications

Typical applications include limited temperature, decoupling and bypass.

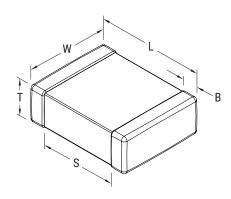


Ordering Information

Packaging C-Spec Ordering Options Table

Packaging Type ¹	Packaging/Grade Ordering Code (C-Spec)			
Bulk Bag/Unmarked	Not required (Blank)			
7" Reel/Unmarked	TU			
13" Reel/Unmarked	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)			
7" Reel/Marked	TM			
13" Reel/Marked	7040 (EIA 0603 and smaller case sizes) 7215 (EIA 0805 and larger case sizes)			
7" Reel/Unmarked/2mm pitch ²	7081			
13" Reel/Unmarked/2mm pitch ²	7082			

Dimensions - Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0402	1005	1.00 (0.040) ±0.05 (0.002)	0.50 (0.020) ±0.05 (0.002)		0.30 (0.012) ±0.10 (0.004)	0.30 (0.012)	Solder Reflow Only
0603	1608	1.60 (0.063) ±0.15 (0.006)	0.80 (0.032) ±0.15 (0.006)		0.35 (0.014) ±0.15 (0.006)	0.70 (0.028)	-
0805	2012	2.00 (0.079) ±0.20 (0.008)	1.25 (0.049) ±0.20 (0.008)	See Table 2 for Thickness	0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder Wave or Solder Reflow
1206	3216	3.20 (0.126) ±0.20 (0.008)	1.60 (0.063) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	NI/A	
1210	3225	3.20 (0.126) ±0.20 (0.008)	2.50 (0.098) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	N/A	Solder Reflow Only



Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions.

Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-30°C to +85°C
Capacitance Change with Reference to +25°C and 0 Vdc Applied (TCC)	+22%, -82%
¹ Aging Rate (Maximum % Capacitance Loss/Decade Hour)	7.0%
² Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5±1 seconds and charge/discharge not exceeding 50mA)
³ Dissipation Factor (DF) Maximum Limit at 25°C	10% (6.3 V and 10 V), 7% (16 V and 25 V) and 5% (50 V)
⁴ Insulation Resistance (IR) Minimum Limit at 25°C	See Insulation Resistance Limit Table (Rated voltage applied for 120±5 seconds at 25°C)

Post Environmental Limits

	High Temperature Life, Biased Humidity, Moisture Resistance											
Dielectric Rated DC Capacitance Dissipation Factor Capacitance Insulation (Maximum %) Shift Resistance												
	> 25		7.5		10% of Initial Limit							
Y5V	16/25	All	10.0	±30%								
	< 16		15.0		Lillit							

Insulation Resistance Limit Table

EIA Case Size	100 Megohm Microfarads or 10 GΩ	50 Megohm Microfarads or 10 GΩ
All	≥ 16 V	≤ 10 V



Table 1 - Capacitance Range/Selection Waterfall (0402 - 1210 Case Sizes)

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Table 2A – Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper Q	uantity ¹	Plastic (Quantity
Code	Size	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
BB	0402	0.50 ± 0.05	10,000	50,000	0	0
CF	0603	0.80 ± 0.07*	4,000	15,000	0	0
CG	0603	0.80 ± 0.10*	4,000	15,000	0	0
DN	0805	0.78 ± 0.10*	4,000	15,000	0	0
DO	0805	0.80 ± 0.10*	4,000	15,000	0	0
DP	0805	0.90 ± 0.10*	4,000	15,000	0	0
DL	0805	0.95 ± 0.10	0	0	4,000	10,000
DF	0805	1.10 ± 0.10	0	0	2,500	10,000
DG	0805	1.25 ± 0.15	0	0	2,500	10,000
EB	1206	0.78 ± 0.10	4,000	10,000	4,000	10,000
EC	1206	0.90 ± 0.10	0	0	4,000	10,000
ED	1206	1.00 ± 0.10	0	0	2,500	10,000
EP	1206	1.20 ± 0.20	0	0	2,500	10,000
EH	1206	1.60 ± 0.20	0	0	2,000	8,000
EJ	1206	1.70 ± 0.20	0	0	2,000	8,000
FD	1210	0.95 ± 0.10	0	0	4,000	10,000
FE	1210	1.00 ± 0.10	0	0	2,500	10,000
FF	1210	1.10 ± 0.10	0	0	2,500	10,000
FG	1210	1.25 ± 0.15	0	0	2,500	10,000
FH	1210	1.55 ± 0.15	0	0	2,000	8,000
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000
FT	1210	1.90 ± 0.20	0	0	2,000	8,000
FS	1210	2.50 ± 0.30	0	0	1,000	4,000
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel
Code	Size1	Range (mm)	Paper Q	uantity ¹	Plastic (Quantity



Table 2B - Bulk Packaging Quantities

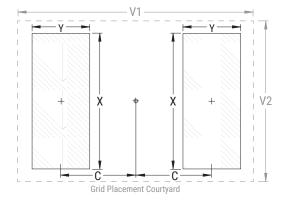
Dealessing Type	Loose Packaging
Packaging Type	Bulk Bag



Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351

EIA Size Code	ze Size Maximum (Most)					Density Level B: Median (Nominal) Land Protrusion (mm)				Density Level C: Minimum (Least) Land Protrusion (mm)						
Couc	Odde	С	Y	X	V1	V2	С	Y	X	V1	V2	С	Y	X	V1	V2
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90
1210¹	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00







Soldering Process

Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are

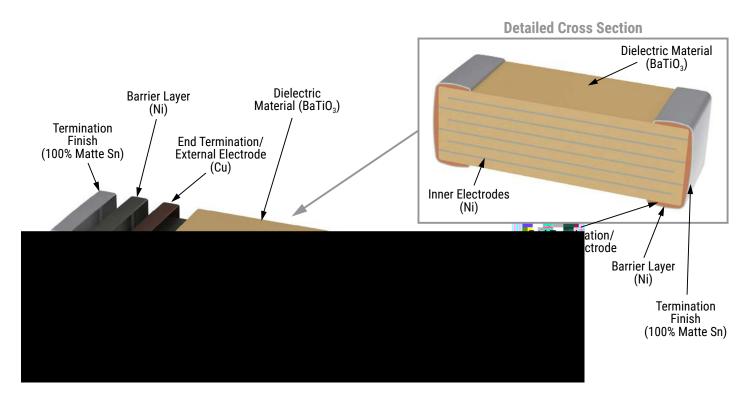


Table 4 – Performance & Reliability: Test Methods and Conditions

Stress	Reference	Test or Inspection Method							
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.							
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for COG. Flexible termination system – 3.0 mm (minimum).							
		Magnification 50 X. Conditions:							
Coldorability	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C							
Solderability	J-51D-002	b) Method B at 215°C category 3							
		c) Method D, category 3 at 260°C							
Temperature Cycling	JESD22 Method JA-104	1,000 Cycles (-55°C to +125°C). Measurement at 24 hours +/- 4 hours after test conclusion.							
Biased Humidity	MIL-STD-202 Method	Load Humidity: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor. Measurement at 24 hours +/- 4 hours after test conclusion.							
,	103	Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours +/- 4 hours after test conclusion.							
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Meha- Meha-							



Construction (Typical)



Capacitor Marking (Optional):

Laser marking option is not available on:

- · COG, Ultra Stable X8R and Y5V dielectric devices
- · EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

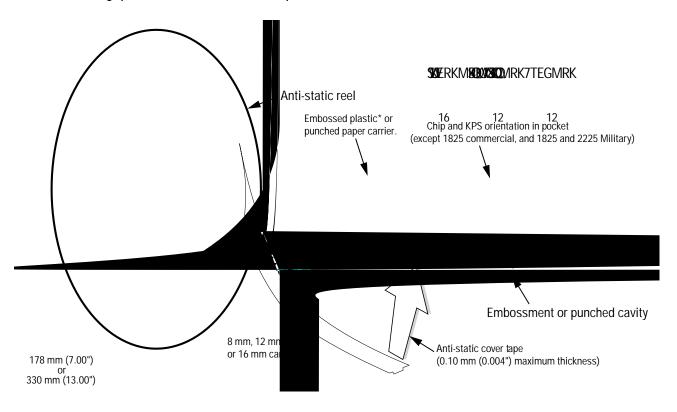




Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

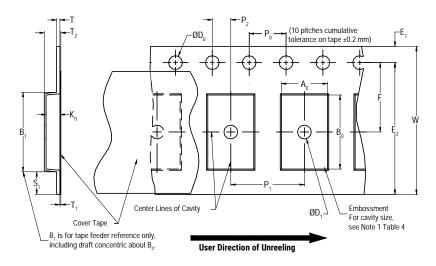




Figure 2 - Punched (Paper) Carrier Tape Dimensions

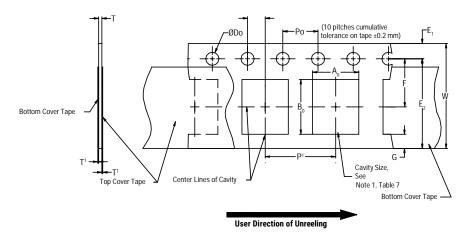


Table 7 - Punched (Paper) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)											
Tape Size	D _o	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2					
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) maximum	0.75 (0.030)	25 (0.984)					



Packaging Information Performance Notes

1. Cover Tape Break Force: 1.0 kg minimum.

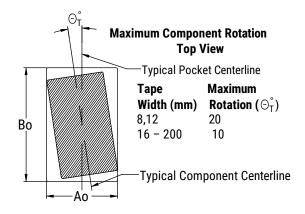
2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength	
8 mm	0.1 to 1.0 newton (10 to 100 gf)	
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)	

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes.

Figure 3 – Maximum Component Rotation



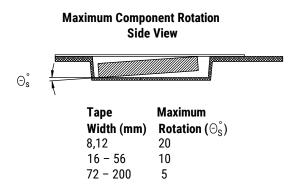


Figure 4 - Maximum Lateral Movement

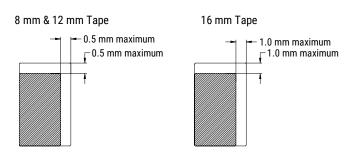


Figure 5 - Bending Radius

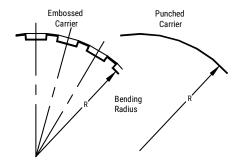
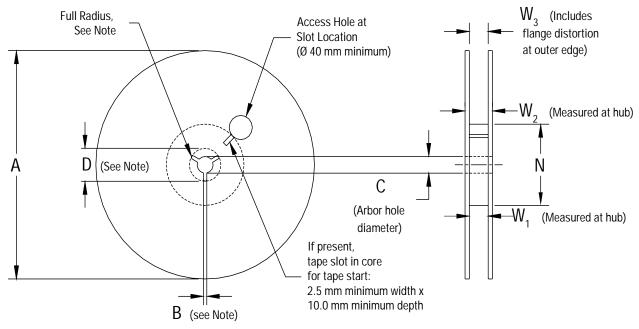




Figure 6 - Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

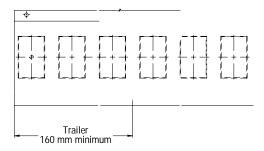
Table 8 - Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)					
Tape Size	A	B Minimum	С	D Minimum	
8 mm	178 ±0.20 (7.008 ±0.008) or 330 ±0.20 (13.000 ±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)	
12 mm					
16 mm					
Variable Dimensions — Millimeters (Inches)					
Tape Size	N Minimum	W ₁	W ₂ Maximum	W_3	
8 mm	50 (1.969)	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)		
12 mm		12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference	
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)		



Figure 7 – Tape Leader & Trailer Dimensions





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